



SEMiX® 3s

SEMiX223GB12Vs

Features

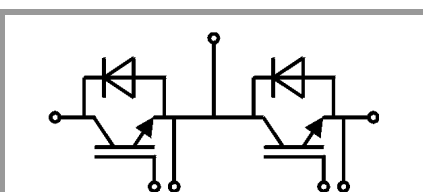
- Homogeneous Si
- $V_{CE(sat)}$ with positive temperature coefficient
- High short circuit capability
- UL recognised file no. E63532

Typical Applications*

- AC inverter drives
- UPS
- Electronic Welding

Remarks

- Case temperature limited to $T_C=125^\circ\text{C}$ max.
- Product reliability results are valid for $T_J=150^\circ\text{C}$
- Dynamic values apply to the following combination of resistors:
 $R_{Gon,main} = 2,9 \Omega$
 $R_{Goff,main} = 2,9 \Omega$
 $R_{G,X} = 2,2 \Omega$
 $R_{E,X} = 0,5 \Omega$



GB

| Absolute Maximum Ratings | | | | |
|--------------------------|--|-------------------------|-------------|------|
| Symbol | Conditions | | Values | Unit |
| IGBT | | | | |
| V _{CES} | T _j = 25 °C | | 1200 | V |
| I _C | T _j = 175 °C | T _c = 25 °C | 323 | A |
| | | T _c = 80 °C | 246 | A |
| I _{Cnom} | | | 225 | A |
| I _{CRM} | I _{CRM} = 3xI _{Cnom} | | 675 | A |
| V _{GES} | | | -20 ... 20 | V |
| t _{psc} | V _{CC} = 720 V V _{GE} ≤ 15 V V _{CES} ≤ 1200 V | T _j = 125 °C | 10 | μs |
| T _j | | | -40 ... 175 | °C |
| Inverse diode | | | | |
| I _F | T _j = 175 °C | T _c = 25 °C | 263 | A |
| | | T _c = 80 °C | 197 | A |
| I _{Fnom} | | | 225 | A |
| I _{FRM} | I _{FRM} = 3xI _{Fnom} | | 675 | A |
| I _{FSM} | t _p = 10 ms, sin 180°, T _j = 25 °C | | 1161 | A |
| T _j | | | -40 ... 175 | °C |
| Module | | | | |
| I _{t(RMS)} | T _{terminal} = 80 °C | | 600 | A |
| T _{stg} | | | -40 ... 125 | °C |
| V _{isol} | AC sinus 50Hz, t = 1 min | | 4000 | V |

| Characteristics | | | | | | |
|----------------------|--|-------------------------|------|------|------|------|
| Symbol | Conditions | | min. | typ. | max. | Unit |
| IGBT | | | | | | |
| V _{CE(sat)} | I _C = 225 A | T _j = 25 °C | | 1.85 | 2.3 | V |
| | V _{GE} = 15 V chipelevel | T _j = 150 °C | | 2.3 | 2.55 | V |
| V _{CE0} | | T _j = 25 °C | | 0.94 | 1.04 | V |
| | | T _j = 150 °C | | 0.88 | 0.98 | V |
| r _{CE} | V _{GE} = 15 V | T _j = 25 °C | | 4.0 | 5.6 | mΩ |
| | | T _j = 150 °C | | 6.1 | 7.0 | mΩ |
| V _{GE(th)} | V _{GE} =V _{CE} , I _C = 9 mA | | 5.5 | 6 | 6.5 | V |
| I _{CES} | V _{GE} = 0 V | T _j = 25 °C | | 0.1 | 0.3 | mA |
| | V _{CE} = 1200 V | T _j = 150 °C | | | | mA |
| C _{ies} | V _{CE} = 25 V V _{GE} = 0 V | f = 1 MHz | | 13.5 | | nF |
| C _{oes} | | f = 1 MHz | | 1.33 | | nF |
| C _{res} | | f = 1 MHz | | 1.33 | | nF |
| Q _G | V _{GE} = - 8 V...+ 15 V | | | 2460 | | nC |
| R _{Gint} | T _j = 25 °C | | | 3.33 | | Ω |
| t _{d(on)} | V _{CC} = 600 V | T _j = 150 °C | | 470 | | ns |
| t _r | I _C = 225 A | T _j = 150 °C | | 72 | | ns |
| E _{on} | V _{GE} = ±15 V | T _j = 150 °C | | 19.9 | | mJ |
| t _{d(off)} | R _{G on} = 3.8 Ω | T _j = 150 °C | | 665 | | ns |
| t _f | R _{G off} = 3.8 Ω | T _j = 150 °C | | 109 | | ns |
| | di/dt _{on} = 3200 A/μs | T _j = 150 °C | | | | |
| E _{off} | di/dt _{off} = 2000 A/μs du/dt _{off} = 6600 V/μs | T _j = 150 °C | | 27.2 | | mJ |
| R _{th(j-c)} | per IGBT | | | | 0.14 | K/W |



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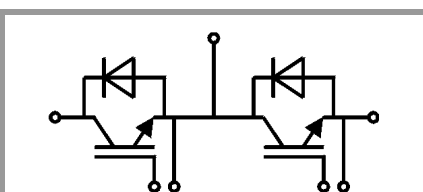
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| Characteristics | | | | | | |
|----------------------------------|--|-------------------------|------|-------------|------|------|
| Symbol | Conditions | | min. | typ. | max. | Unit |
| Inverse diode | | | | | | |
| V _F = V _{EC} | I _F = 225 A V _{GE} = 0 V chip | T _j = 25 °C | | 2.2 | 2.49 | V |
| | | T _j = 150 °C | | 2.1 | 2.4 | V |
| V _{F0} | | T _j = 25 °C | 1.1 | 1.3 | 1.5 | V |
| | | T _j = 150 °C | 0.7 | 0.9 | 1.1 | V |
| r _F | | T _j = 25 °C | 3.6 | 3.9 | 4.4 | mΩ |
| | | T _j = 150 °C | 4.7 | 5.4 | 5.9 | mΩ |
| I _{RRM} | I _F = 225 A di/dt _{off} = 3400 A/μs V _{GE} = -15 V V _{CC} = 600 V | T _j = 150 °C | | 210 | | A |
| Q _{rr} | | T _j = 150 °C | | 39.4 | | μC |
| E _{rr} | | T _j = 150 °C | | 16.4 | | mJ |
| R _{th(j-c)} | | per diode | | | 0.23 | K/W |
| Module | | | | | | |
| L _{CE} | | | | 20 | | nH |
| R _{CC'+EE'} | res., terminal-chip | T _C = 25 °C | | 0.7 | | mΩ |
| | | T _C = 125 °C | | 1 | | mΩ |
| R _{th(c-s)} | per module | | | 0.04 | | K/W |
| M _s | to heat sink (M5) | | 3 | | 5 | Nm |
| M _t | | to terminals (M6) | 2.5 | | 5 | Nm |
| | | | | | | Nm |
| w | | | | | 300 | g |
| Temperatur Sensor | | | | | | |
| R ₁₀₀ | T _c =100°C (R ₂₅ =5 kΩ) | | | 493 ± 5% | | Ω |
| B _{100/125} | R(T)=R ₁₀₀ exp[B _{100/125} (1/T-1/T ₁₀₀)]; T[K]; | | | 3550 ±2% | | K |



GB

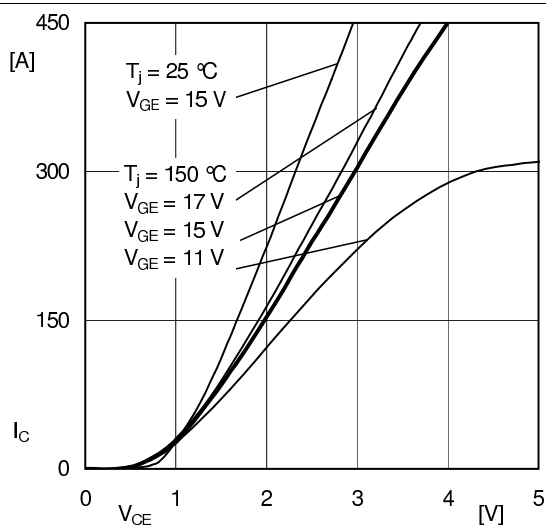


Fig. 1: Typ. output characteristic, inclusive $R_{CC'+EE'}$

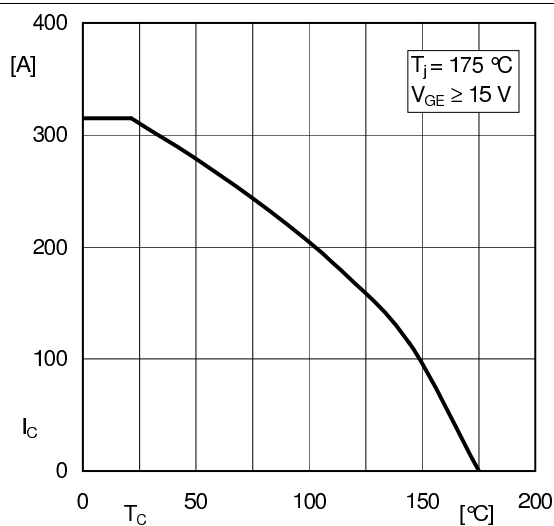


Fig. 2: Rated current vs. temperature $I_C = f(T_C)$

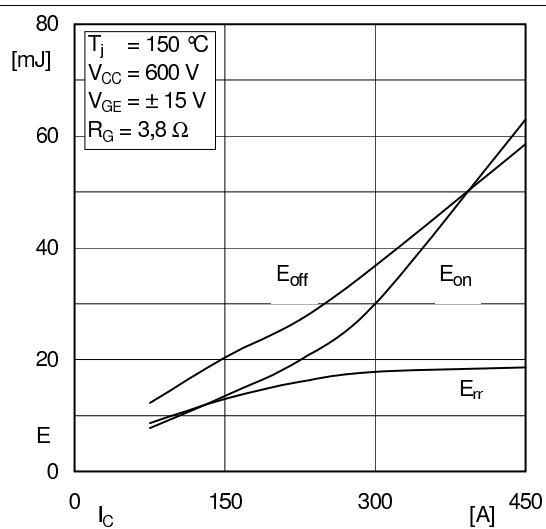


Fig. 3: Typ. turn-on /-off energy = $f(I_C)$

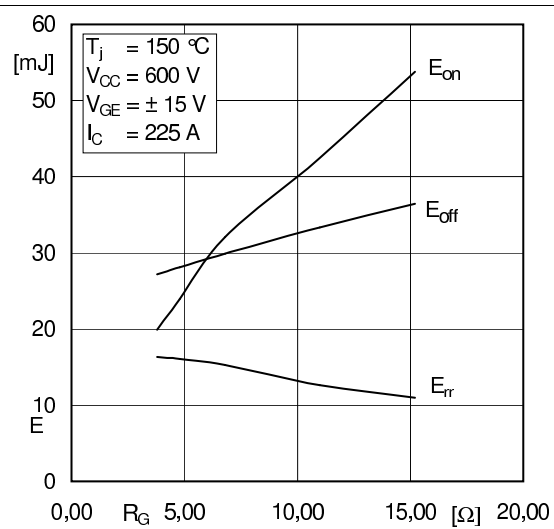


Fig. 4: Typ. turn-on /-off energy = $f(R_G)$

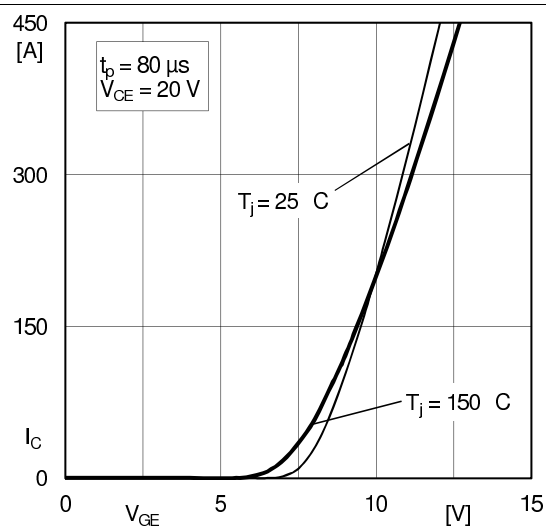


Fig. 5: Typ. transfer characteristic

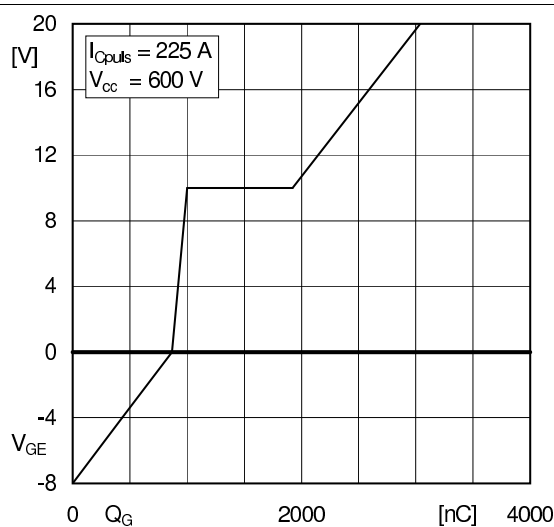


Fig. 6: Typ. gate charge characteristic

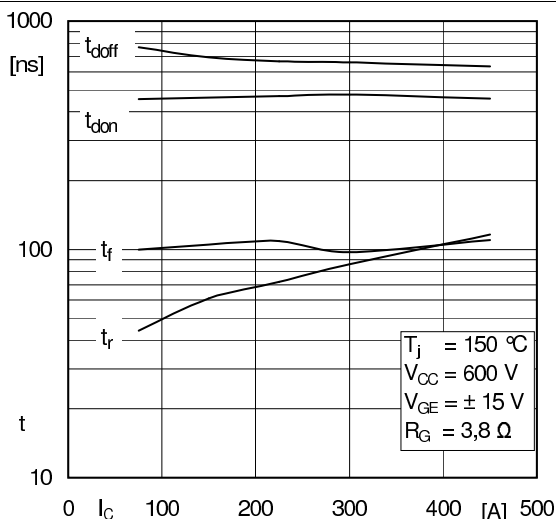


Fig. 7: Typ. switching times vs. I_C

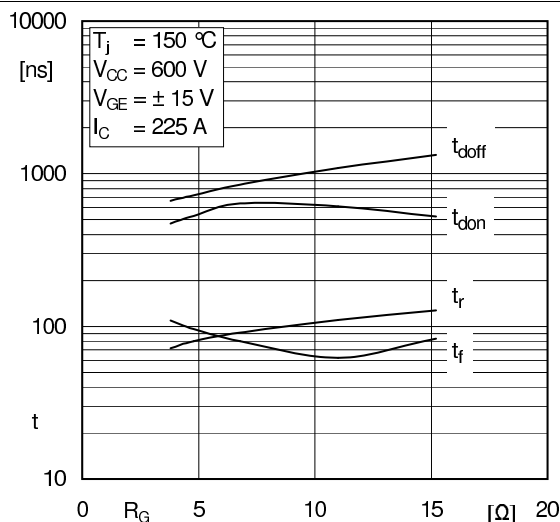


Fig. 8: Typ. switching times vs. gate resistor R_G

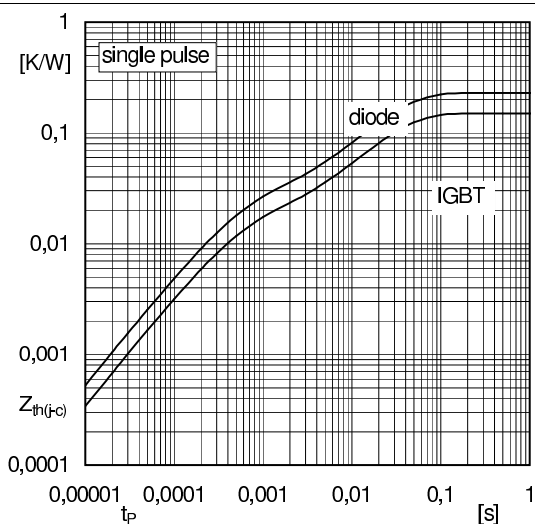


Fig. 9: Typ. transient thermal impedance

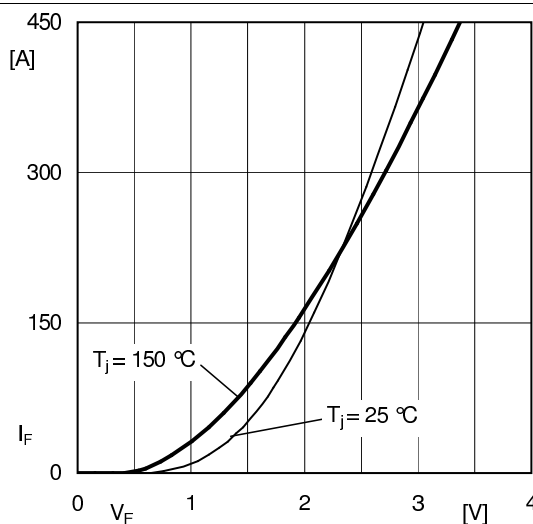


Fig. 10: Typ. CAL diode forward charact., incl. $R_{CC'+EE'}$

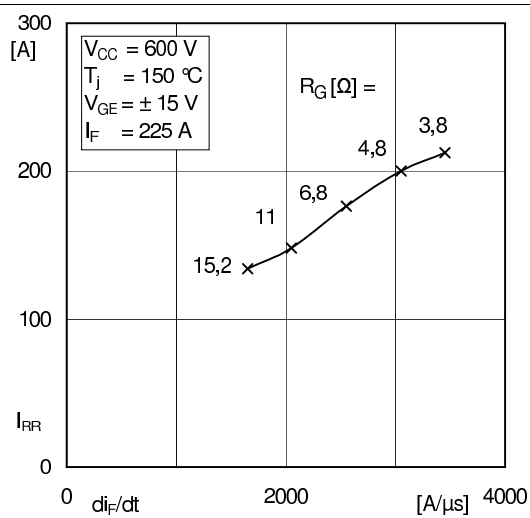


Fig. 11: Typ. CAL diode peak reverse recovery current

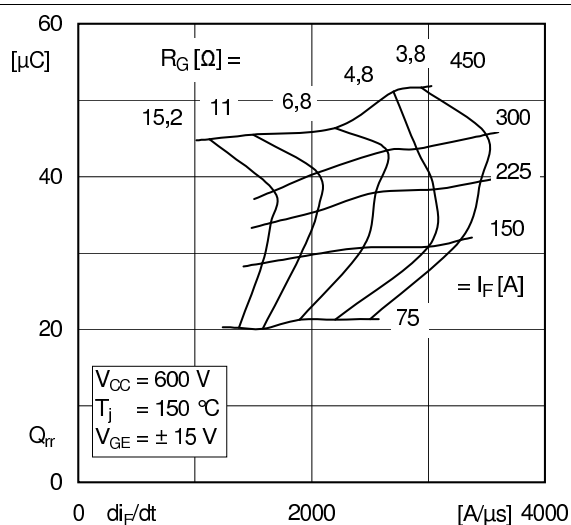
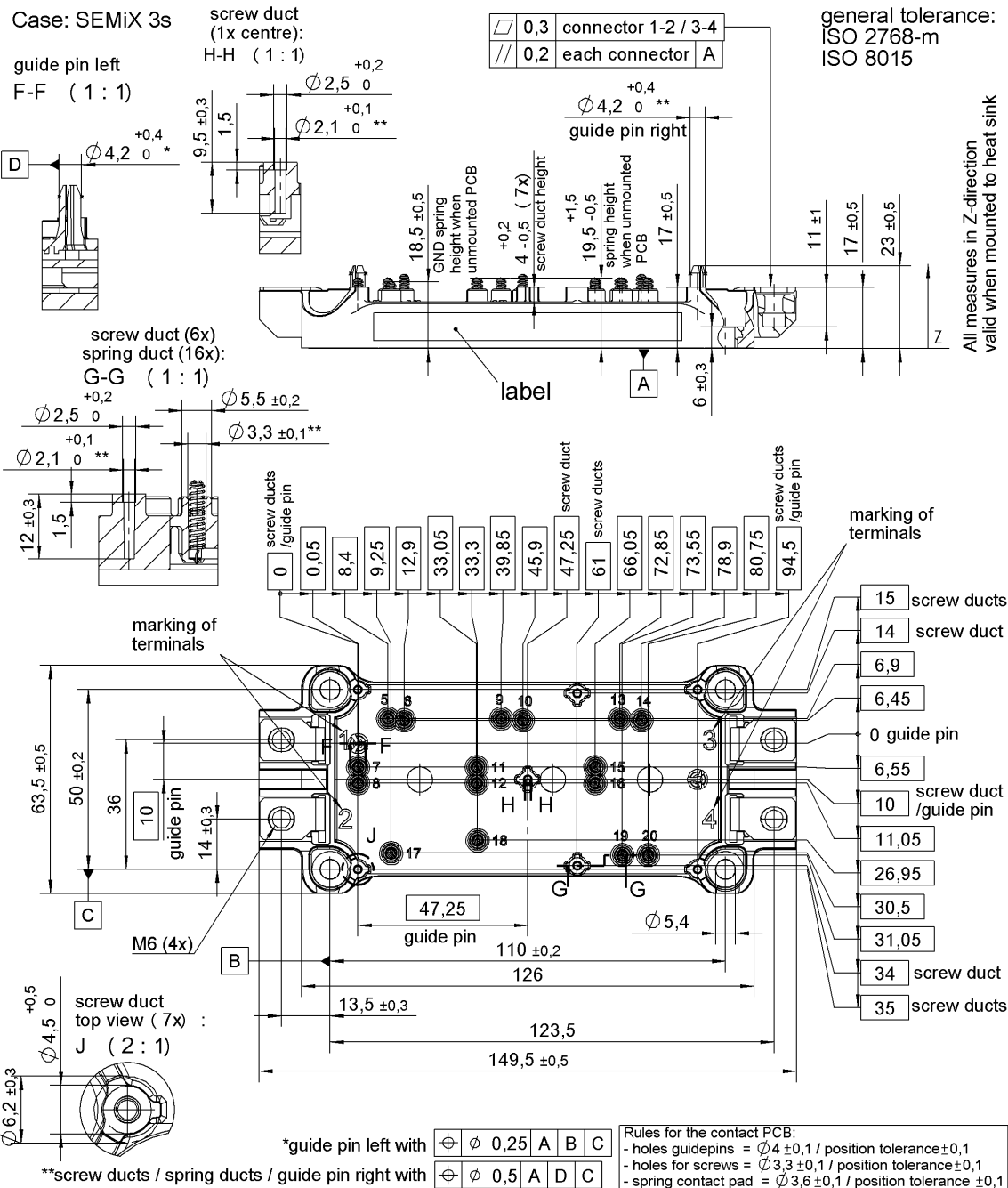
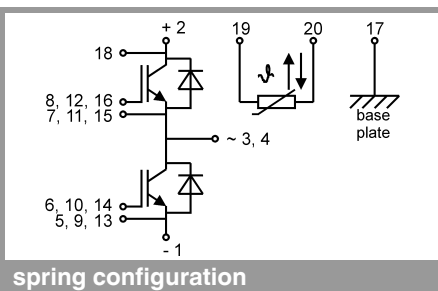


Fig. 12: Typ. CAL diode recovery charge



SEMiX 3s



This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our staff.